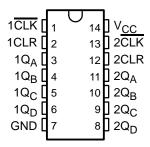
- 2-V to 5.5-V V_{CC} Operation
- Max t_{pd} of 10 ns at 5 V
- Typical V_{OLP} (Output Ground Bounce)
 <0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot)
 >2.3 V at V_{CC} = 3.3 V, T_A = 25°C
- I_{off} Supports Partial-Power-Down-Mode Operation
- Dual 4-Bit Binary Counters With Individual Clocks
- Direct Clear for Each 4-Bit Counter
- Can Significantly Improve System
 Densities by Reducing Counter Package
 Count by 50 Percent
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

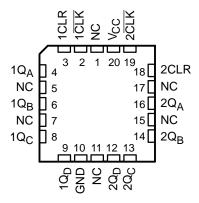
description/ordering information

The 'LV393A devices contain eight flip-flops and additional gating to implement two individual 4-bit counters in a single package. These devices are designed for 2-V to 5.5-V V_{CC} operation.

SN54LV393A . . . J OR W PACKAGE SN74LV393A . . . D, DB, DGV, NS, OR PW PACKAGE (TOP VIEW)



SN54LV393A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

ORDERING INFORMATION

TA	PACK	AGE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	SOIC - D	Tube of 50	SN74LV393AD	LV393A
	3010 = 0	Reel of 2500	SN74LV393ADR	LV393A
	SOP - NS	Reel of 2000	SN74LV393ANSR	74LV393A
-40°C to 85°C	SSOP – DB	Reel of 2000	SN74LV393ADBR	LV393A
-40 C to 65 C		Tube of 90	SN74LV393APW	
	TSSOP – PW	Reel of 2000	SN74LV393APWR	LV393A
		Reel of 250	SN74LV393APWT	
	TVSOP – DGV	Reel of 2000	SN74LV393ADGVR	LV393A
	CDIP – J	Tube of 25	SNJ54LV393AJ	SNJ54LV393AJ
–55°C to 125°C	CFP – W	Tube of 150	SNJ54LV393AW	SNJ54LV393AW
	LCCC – FK	Tube of 55	SNJ54LV393AFK	SNJ54LV393AFK

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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description/ordering informaton (continued)

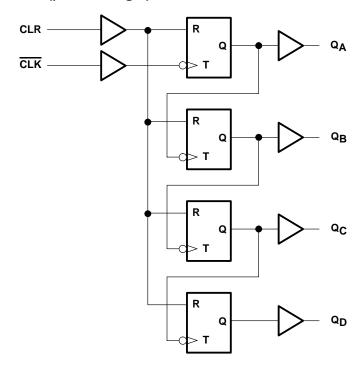
These devices comprise two independent 4-bit binary counters, each having a clear (CLR) and a clock ($\overline{\text{CLK}}$) input. These devices change state on the negative-going transition of the $\overline{\text{CLK}}$ pulse. N-bit binary counters can be implemented with each package, providing the capability of divide by 256. The 'LV393A devices have parallel outputs from each counter stage so that any submultiple of the input count frequency is available for system timing signals.

These devices are fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down.

FUNCTION TABLE

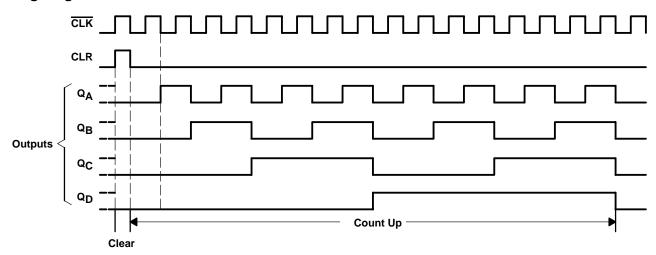
INP	UTS	FUNCTION
CLK	CLR	FUNCTION
1	L	No change
\downarrow	L	Advance to next stage
×	Н	All outputs L

logic diagram, each counter (positive logic)





timing diagram



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	0.5 V to 7 V
Input voltage range, V _I (see Note 1)	0.5 V to 7 V
Output voltage range applied in high or low state, VO (see Note	s 1 and 2)—0.5 V to V _{CC} + 0.5 V
Output voltage range applied in power-off state, VO (see Note 1	l) –0.5 V to 7 V
Input clamp current, I_{IK} ($V_I < 0$)	−20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC})	±50 mA
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$	±25 mA
Continuous current through V _{CC} or GND	±50 mA
Package thermal impedance, θ_{JA} (see Note 3): D package	86°C/W
DB package .	96°C/W
DGV package	127°C/W
NS package .	76°C/W
PW package .	113°C/W
Storage temperature range, T _{stg}	—65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

- 2. This value is limited to 7 V maximum.
- 3. The package thermal impedance is calculated in accordance with JESD 51-7.



recommended operating conditions (see Note 4)

			SN54L	LV393A	SN74L	V393A	UNIT
			MIN	MAX	MIN	MAX	UNII
Vcc	Supply voltage		2	5.5	2	5.5	V
		V _{CC} = 2 V	1.5		1.5		
\ _{\/}	High-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	V _{CC} × 0.7		$V_{CC} \times 0.7$		V
VIH	riigii-ieveriiiput voitage	$V_{CC} = 3 V \text{ to } 3.6 V$	V _{CC} ×0.7		$V_{CC} \times 0.7$		v
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	V _{CC} ×0.7		$V_{CC} \times 0.7$		
		V _{CC} = 2 V		0.5		0.5	
VIL	Low-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		$V_{CC} \times 0.3$		$VCC \times 0.3$	V
VIL	Low-level input voltage	$V_{CC} = 3 V \text{ to } 3.6 V$		$V_{CC} \times 0.3$		$VCC \times 0.3$	v
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		$V_{CC} \times 0.3$		$V_{CC} \times 0.3$	
٧I	Input voltage		0	5.5	0	5.5	V
٧o	Output voltage		0	Vcc	0	VCC	V
		V _{CC} = 2 V	3	– 50		- 50	μΑ
	High-level output current	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	90	-2		-2	
ЮН	riign-ieveroutput current	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$	Q'	-6		-6	mA
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		-12		-12	
		V _{CC} = 2 V		50		50	μΑ
lo	Low-level output current	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2		2	
IOL	Low-level output current	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$		6		6	mA
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		12		12	
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		200		200	
Δt/Δν	Input transition rise or fall rate	V _{CC} = 3 V to 3.6 V		100		100	ns/V
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		20		20	
TA	Operating free-air temperature		- 55	125	-40	85	°C

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CONDITIONS	.,	SN5	4LV393A	ı.	SN74	LV393A	١	UNIT
PARAMETER	TEST CONDITIONS	vcc	MIN	TYP	MAX	MIN	TYP	MAX	UNII
	I _{OH} = -50 μA	2 V to 5.5 V	V _{CC} -0.1			V _{CC} -0.1			
Vari	I _{OH} = -2 mA	2.3 V	2			2			V
VOH	I _{OH} = -6 mA	3 V	2.48			2.48			v
	I _{OH} = -12 mA	4.5 V	3.8	W.		3.8			
	I _{OL} = 50 μA	2 V to 5.5 V		A	0.1			0.1	
Voi	I _{OL} = 2 mA	2.3 V		Q	0.4			0.4	V
VOL	I _{OL} = 6 mA	3 V		Ċ,	0.44			0.44	v
	I _{OL} = 12 mA	4.5 V	9		0.55			0.55	
lı	V _I = 5.5 V or GND	0 to 5.5 V	0		±1			±1	μΑ
^I CC	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			20			20	μΑ
l _{off}	V_I or $V_O = 0$ to 5.5 V	0			5			5	μΑ
Ci	$V_I = V_{CC}$ or GND	3.3 V		1.8			1.8		pF

timing requirements over recommended operating free-air temperature range, V_{CC} = 2.5 V \pm 0.2 V (unless otherwise noted) (see Figure 1)

			T _A = 2	25°C	SN54L	V393A	SN74L\	/393A	UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	UNIT
Ţ.	Pulse duration	CLK high or low	5		5	10,4	5		no
ι _W	ruise duration	CLR high	5		5	ALC.	5		ns
t _{su}	Setup time	CLR inactive before CLK↓	6		6		6		ns

timing requirements over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

			T _A = 2	25°C	SN54L	V393A	SN74L\	/393A	UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	UNIT
Γ.	Pulse duration	CLK high or low	5		5	10,4	5		no
t _W	ruise duration	CLR high	5		5	AL.	5		ns
t _{su}	Setup time	CLR inactive before CLK↓	5		5		5		ns

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

			T _A = 2	25°C	SN54L	V393A	SN74L\	/393A	UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	UNIT
Γ.	Pulse duration	CLK high or low	5		5	10,4	5		20
t _W	Fulse duration	CLR high	5		5	ALC.	5		ns
t _{su}	Setup time	CLR inactive before CLK↓	4		4		4		ns

switching characteristics over recommended operating free-air temperature range, V_{CC} = 2.5 V \pm 0.2 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T,	չ = 25°C	;	SN54L	V393A	SN74L	/393A	UNIT	
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNII	
4			C _L = 15 pF	50*	90*		40*		40		MHz	
f _{max}			C _L = 50 pF	30	70		25		25		IVITIZ	
		Q_A			7.1*	17.7*	1*	20.5*	1	20.5		
		Q _B			8.5*	20.3*	1*	23.5*	1	23.5		
^t pd	CLK	QC	C _L = 15 pF		10*	22.5*	1*	26*	1	26	ns	
		Q_{D}			11.1*	24.2*	1*	28*	1	28		
t _{PHL}	CLR	Qn			6.7*	14.8*	1*	17*	1	17		
		Q _A			9.3	21.3	7	24.5	1	24.5		
		QB			10.9	23.9	Q 1	27.5	1	27.5		
^t pd	CLK	QC	C _L = 50 pF	C _L = 50 pF		12.3	26.1	1	30	1	30	ns
		Q_{D}			13.4	27.8	1	32	1	32		
t _{PHL}	CLR	Q _n			9.1	17.4	1	20	1	20		

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested

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switching characteristics over recommended operation free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T,	4 = 25°C	;	SN54L	V393A	SN74L	/393A	UNIT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNII
f			C _L = 15 pF	75*	130*		65*		65		MHz
f _{max}			$C_{L} = 50 \text{ pF}$	45	105		35		35		IVII IZ
		Q_A			5.1*	13.2*	1*	15.5*	1	15.5	
. .	CLK	QB			6*	15.8*	1*	18.5*	1	18.5	
t _{pd}	CLK	QC	C _L = 15 pF		7*	18*	1*	21*	1	21	ns
		Q_{D}			7.7*	19.7*	1*	23*	1	23	
^t PHL	CLR	Qn			5.1*	12.3*	1*	14.5*	1	14.5	
		Q_A			6.7	16.7	777	19	1	19	
. .	CLK	QB			7.8	19.3	ر الا	22	1	22	
t _{pd}	CLK	QC	C _L = 50 pF		8.7	21.5	1	24.5	1	24.5	ns
		Q_{D}			9.5	23.2	1	26.5	1	26.5	
t _{PHL}	CLR	Qn			6.8	15.8	1	18	1	18	

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

DADAMETED	FROM	то	LOAD	T,	Δ = 25°C	;	SN54L\	/393A	SN74L	/393A	LIAUT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
4			C _L = 15 pF	125*	185*		105*		105		MHz
f _{max}			C _L = 50 pF	85	150		75		75		IVIITZ
		Q_A			3.7*	8.5*	1*	10*	1	10	
.		QB			4.3*	9.8*	1*	11.5*	1	11.5	
^t pd	CLK	QC	C _L = 15 pF		4.9*	11.2*	1*	13*	1	13	ns
		Q_D			5.3*	12.5*	1*	14.5*	1	14.5	
^t PHL	CLR	Qn			3.9*	8.1*	1*	9.5*	1	9.5	
		Q_A			4.9	10.5	70	12	1	12	
4 .		QB			5.6	11.8	Q 1	13.5	1	13.5	
^t pd	CLK	QC	$C_{L} = 50 \text{ pF}$		6.2	13.2	1	15	1	15	ns
		Q_D]		6.6	14.5	1	16.5	1	16.5	
^t PHL	CLR	Qn]		5.2	10.1	1	11.5	1	11.5	

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.

noise characteristics, $V_{CC} = 3.3 \text{ V}$, $C_L = 50 \text{ pF}$, $T_A = 25^{\circ}\text{C}$ (see Note 5)

	PARAMETER	SN'	74LV393	SA.	UNIT
	PARAMETER	MIN	TYP	MAX	UNIT
V _{OL(P)}	Quiet output, maximum dynamic V _{OL}		0.3	0.8	V
V _{OL(V)}	Quiet output, minimum dynamic V _{OL}		-0.2	-0.8	V
VOH(V)	Quiet output, minimum dynamic VOH		2.8		V
VIH(D)	High-level dynamic input voltage	2.31			V
V _{IL(D)}	Low-level dynamic input voltage			0.99	V

NOTE 5: Characteristics are for surface-mount packages only.



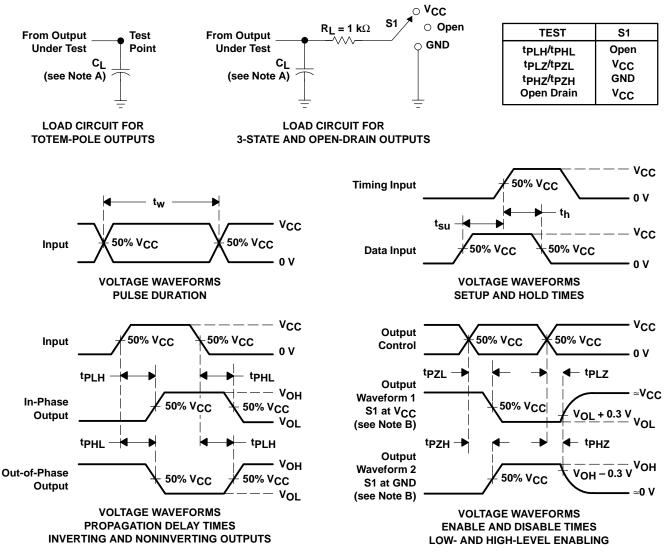
SN54LV393A, SN74LV393A DUAL 4-BIT BINARY COUNTERS

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operating characteristics, $T_A = 25^{\circ}C$

PARAMETER		TEST CONDITIONS		VCC	TYP	UNIT
C _{pd}	Power dissipation capacitance	$C_L = 50 \text{ pF},$	f = 10 MHz	3.3 V	15.2	pF
				5 V	17.3	

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C₁ includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_Q = 50 \Omega$, $t_f \leq 3$ ns, $t_f \leq 3$ ns.
- D. The outputs are measured one at a time with one input transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. t_{PHL} and t_{PLH} are the same as t_{pd} .
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



DGV (R-PDSO-G**)

24 PINS SHOWN

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

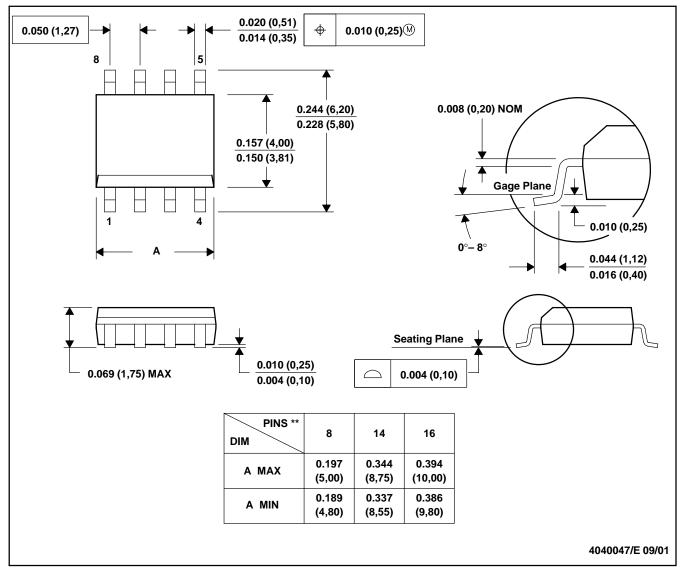
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194

D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

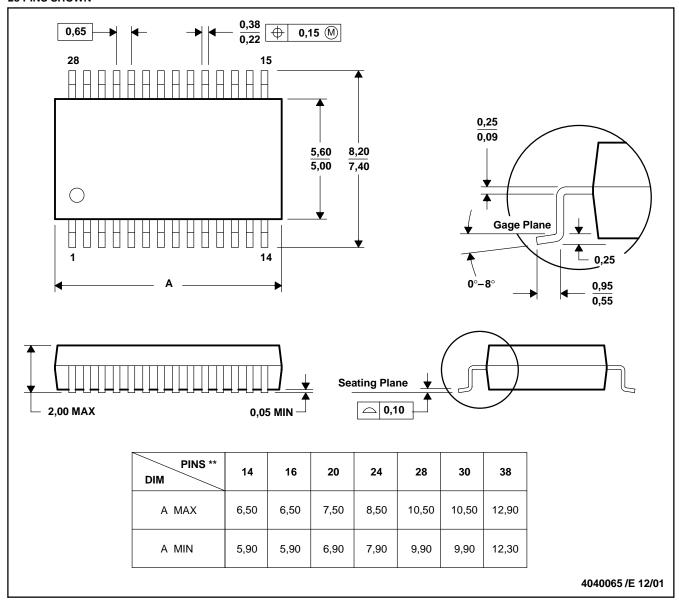
- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

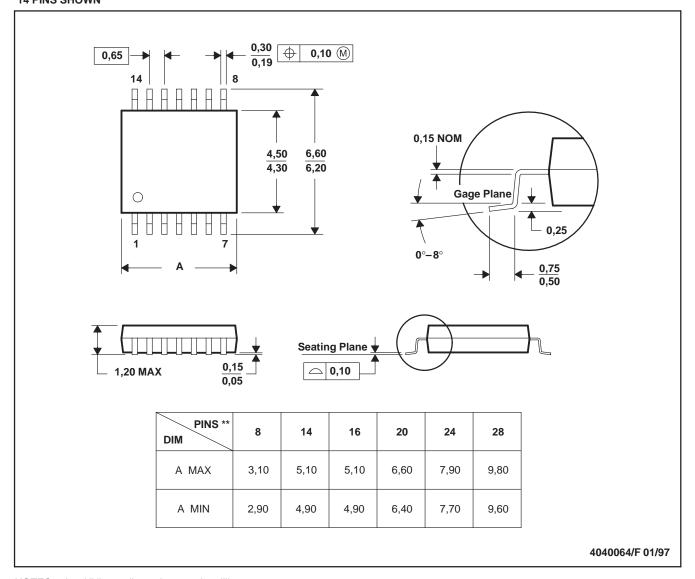
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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